EVERLIGHT ELECTRONICS CO., LTD.

Technical Data Sheet High Power LED – 1W

EVERLIGHT

EHP-AX08EL/GT01H-P01/TR

Features

- Feature of the device: small package with high efficiency
- Typical color temperature: 6300 K
- Typical view angle: 130°.
- Typical high light flux output: 46lm @ 350mA.
- ESD protection.
- Soldering methods: SMT.
- Grouping parameter: total luminous flux, color temperature.
- Optical efficiency: 38 lm/W.
- Thermal resistance (junction to lead): 15 K/W.
- The product itself will remain within RoHS compliant version.

Applications

- TFT LCD display backlight
- Decorative and entertainment illumination
- Signal and symbol luminaries for orientation marker lights (e.g. steps, exit ways, etc.)
- Exterior and interior automotive illumination

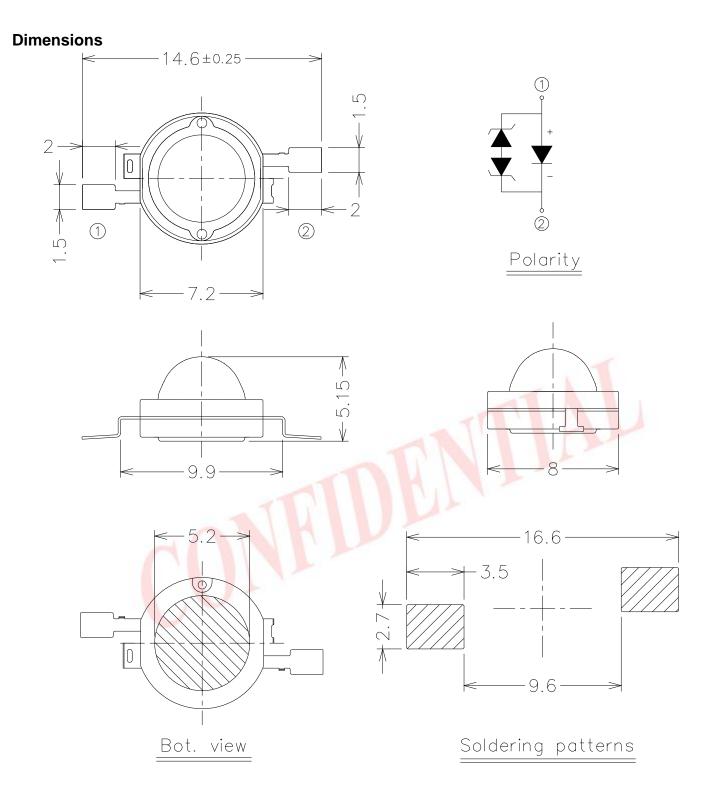
Materials

Materials				
Items	Description			
Housing black body	Heat resistant polymer			
Encapsulating Resin	Silicone resin			
Electrodes	Ag plating copper alloy			
Die attach	Silver paste			
Chip	InGaN			

Prepared by: Edwin Hsiao **Release Date:**







Notes: 1. Dimensions are in millimeters

2. Tolerances unless dimensions ±0.25mm

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Maximum Ratings (T Ambient=25°C)

Parameter	Symbol	Rating	Unit	
Operating Temperature	T _{opr}	-40 ~ +100	°C	
Storage Temperature	T _{stg}	-40 ~ +100	°C	
Junction temperature	Tj	125	٥C	
Forward Current	I _F	500	mA	
Power Dissipation	P _d	2.0	w	
Junction to heat-sink thermal resistance	R _{th}	15	K/W	

Electro-Optical Characteristics (T Ambient=25°C)

Parameter	Bin	Symbol	Min	Тур.	Max	Unit	Condition
Luminous Flux ₍₂₎	J5		45		52		
	K1	$oldsymbol{\phi}_{v}$	52		60	Im	
	K2		60		70		
Forward Voltage ₍₃₎	V1	VF	2.95		3.25	v	l _⊧ =350mA
	V2		3.25		3.55		
	V3		3.55		3.85		
	V4		3.85		4.15		
Viewing Angle ₍₁₎		2θ _{1/2}		130		deg	
Color Temperature		ССТ	4500	6300	10000	к	

Note. 1. $2\theta_{1/2}$ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.

- 2. Luminous flux measurement tolerance : ±10%
- 3. Forward Voltage measurement tolerance : ±0.1V
- 4. X, Y coordination for white light bin areas refer to EHP-A08 series White and Warm White Binning (DSE-A08-001).

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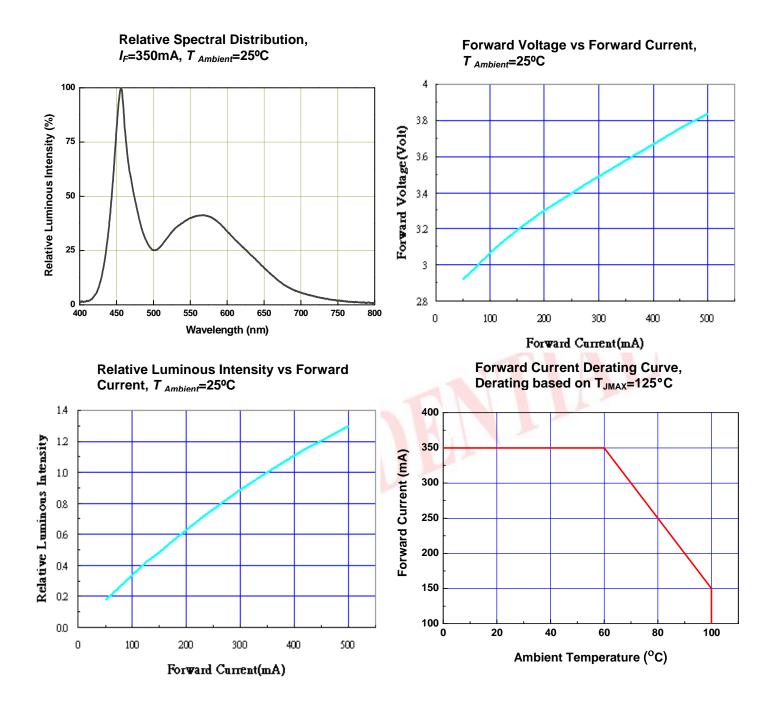
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EHP-AX08EL/GT01H-P01/TR

Typical Electro-Optical Characteristics Curves

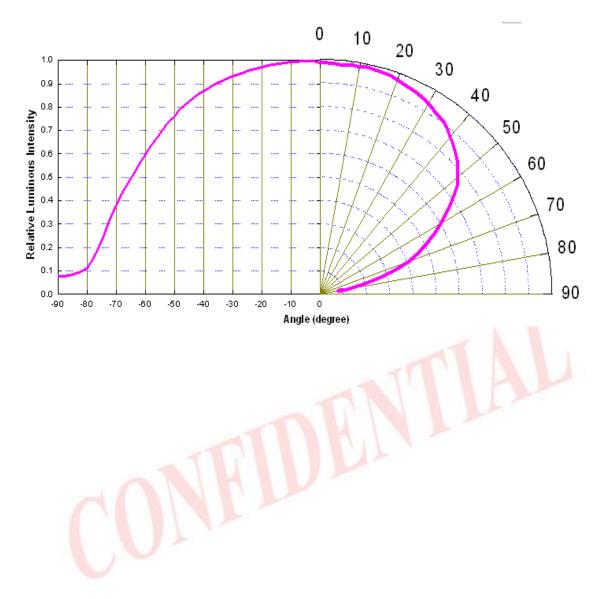


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Typical Representative Spatial Radiation Pattern



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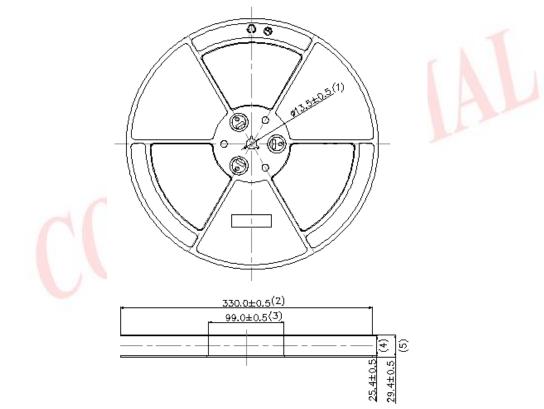
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Label explanation

- **CPN: Customer's Production Number**
- **P/N : Production Number**
- **QTY: Packing Quantity**
- **CAT: Rank of Luminous Flux**
- **HUE: Color Rank**
- **REF: Rank of Forward Voltage**
- **CCT: Color Temperature**
- LOT No: Lot Number
- MADE IN TAIWAN: Production Place

Reel Dimensions





Note: 1. Dimensions are in millimeters

2. The tolerances unless mentioned is ±0.1m

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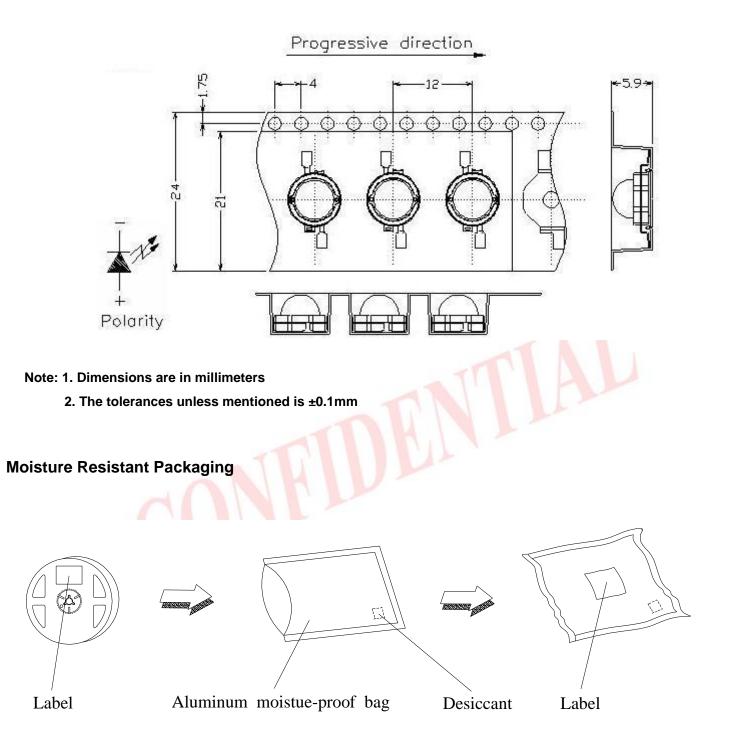
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Carrier Tape Dimensions: Loaded quantity 240 PCS per reel.



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Precautions For Use

1. Over-current-proof

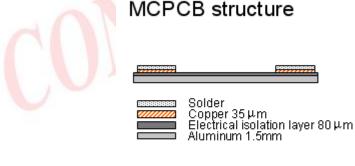
Though EHP-A08 has conducted ESD protection mechanism, customer must not use the device in reverse and should apply resistors for extra protection. Otherwise slight voltage shift may cause enormous current change and burn out failure would happen.

2. Storage

- i. Do not open moisture proof bag before the products are ready to use.
- ii. Before opening the package, the LEDs should be kept at 30 or less and 90%RH or less.
- iii. The LEDs should be used within a year.
- iv. After opening the package, the LEDs should be kept at 30 or less and 70%RH or less.
- v. The LEDs should be used within 168 hours (7 days) after opening the package.
- vi. If the moisture absorbent material (silicone gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
- vii. Pre-curing treatment : 60±5 for 24 hours.

3. Thermal Management

i. For maintaining the high flux output and achieving reliability, EHP-A08 series LED package should be mounted on a metal core printed circuit board (MCPCB) with proper thermal connection to dissipate approximately 1W of thermal energy under 350mA operation.



Recommended supplier:

- Kavano Industrial Co., Ltd.
- TT Electronics
- Special thermal designs are also recommended to take in outer heat sink design, such as FR4
 PCB on Aluminum with thermal vias or FPC on Aluminum with thermal conductive adhesive, etc.
- iii. Sufficient thermal management must be conducted, or the die junction temperature will be over the limit under large electronic driving and LED lifetime will decrease critically.

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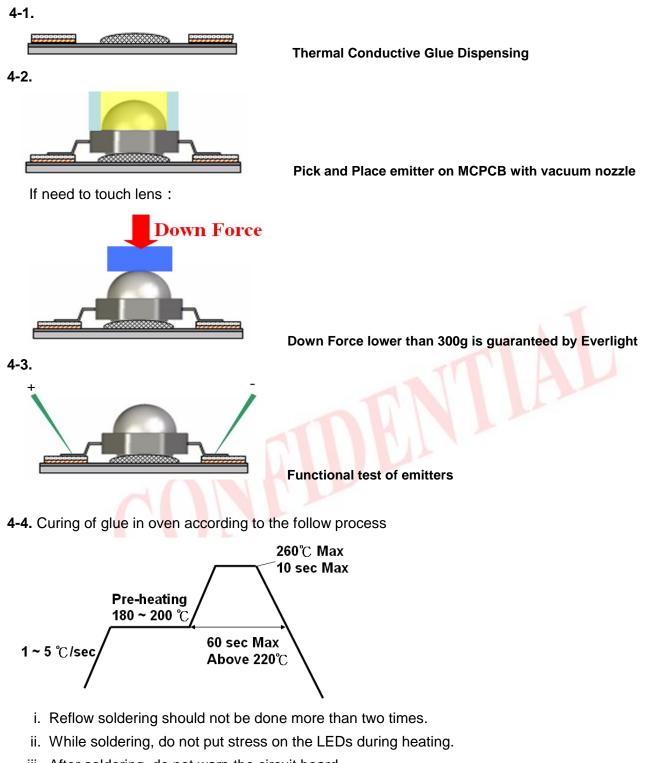
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Expired Period: Forever

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iii. After soldering, do not warp the circuit board

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5. Soldering Iron

- i. For prototype builds or small series production runs it is possible to place and solder the LED by hand.
- Dispensing thermal conductive glue or grease on the substrates and follow its curing spec. Press LED housing to closely connect LED and substrate.
- iii. It is recommended to hand solder the leads with a solder tip temperature of 280°C for less than 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal.
- iv. Be careful because the damage of the product is often started at the time of the hand solder.



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